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Production Custom designs Installation

Mechanical design



MODEL NO : ET027WF01-T

MODEL VERSION: 01

SPEC VERSION : 1.0

ISSUED DATE: 2022-05-21

☐ Preliminary Specification

☒ Final Product Specification

Customer : _____

Approved by	Notes

Youri Confirmation

Prepared by	Reviewed by	Approved by
John	Johnny	Wang

1. Introduction

1.1 Scope of application

LCD specification: Dots 480xRGBx480.

As to basic specification of the driver IC, refer to the IC (Sitronix:ST7701S) specification and data book.

All material & processing of the LCD module should be Lead Free.

1.2 TFT features:

Structure: TFT PANNEL+IC +FPC+BL;

IPS Type LCD

480dot-segment and 480 dot-common outputs;

262K/16.7M Color can be selected by software;

White LED back light;

18bit RGB interface

1.3 Applications:

2. LCM General specification

ITEM	Standard value	Unit
LCD Type	Normally black	--
Drive element	TFT active matrix	--
Number of pixels	480*3RGB(H)X480(V)	Dots
Pixel arrangement	RGB stripe	--
Pixel Pitch (H*V)	0.1461(H) x0.1461(V)	mm
Active area	70.13(H) x 70.13(V)	mm
Viewing direction	ALL O'CLOCK	-
TFT Driver IC	ST7701S	
TFT interface	18bit RGB interface	-
Approx. Weight	TBD	g
LCM Size(W*H*T)	73.03W) x 76.48(H) x2.30(T)	mm
Touch structure		
Touch Driver IC		
Touch Interface		



3.Absolute Maximum Rating

Characteristics	Symbol	Min.	Max.	Unit
LCM Operating Temperature	T _{OPR}	-20	+70	°C
LCM Storage Temperature	T _{STG}	-30	+80	°C
Humidity	RH	-	90	%

4.Electrical Characteristics

4.1 TFT DC Characteristics

Characteristics	Symbol	Min.	Typ.	Max.	Unit
Supply Voltage for I/O	VDDIO	--	--	--	V
Supply Voltage for(DC/DC)	VDD	2.5	2.8	3.3	V
Supply Voltage for(DC/DC)	AVDD				V
Supply Voltage for(DC/DC)	AVEE				V

4.2Back-Light Unit Characeristics

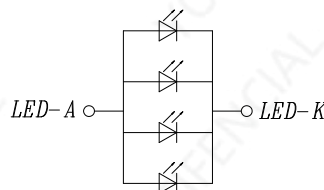
The back-light system is an edge-lighting type with white 4 LEDs. The characteristics of the back-light are shown in the following tables.

Characteristics	Symbol	Min.	Type	Max.	Unit	Notes
Forward Voltage	V _F	5.4	--	6.6	V	-
Forward current	I _F	--	80	-	mA	-
Luminance(With LCD)	L _v		450	--	cd/m ²	-
LED life time	N/A	----	30,000	--	Hr	Note 1

Note:

- (1) The “LED life time” is defined as the module brightness decrease to 50% of original brightness at I_L=20mA/LED. The LED life time could be decreased if operating I_L is larger than 25mA/LED.

Backlight circuit diagram shown in below:

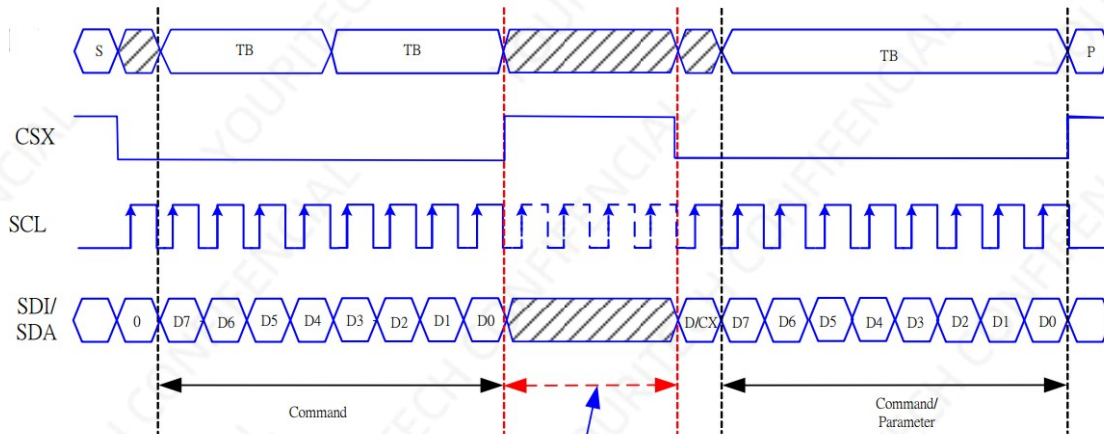


5. Module Function Description

Pin No.	Symbol	LCM Functional	Notes
1	LEDA	Power supply for backlight anode input terminal.	
2~3	LEDK	Power supply for backlight cathode input terminal.	
4	GND	Power Ground	
5	VCC	Power supply: 2.5V ~ 3.3V	
6	RESET	Reset signal input terminal. Active at 'L'.	
7~8	NC	NC	
9	SDA	Input/Output signal pin	
10	SCLK	Serial clock signal.	
11	CS	Chip select signal input pin	
12	DCLK	Dot clock signal for RGB interface operation.	
13	DE	Data enable signal for RGB interface operation.	
14	VSYNC	Vertical (Frame) synchronizing input signal for RGB interface operation.	
15	HSYNC	Horizontal (Line) synchronizing input signal for RGB interface operation.	
16~33	DB0-DB17	RGB interface data bus.	
34	GND	Power Ground	
35	CTP_INT	Touch panel interrupt output	
36	CTP_SDA	Touch panel I2C data	
37	CTP_SCL	Touch panel I2C clock	
38	CTP_RST	Touch panel reset	
39	CTP_VCC	Touch panel Power supply 2.8~3.3V	
40	GND	Power Ground	

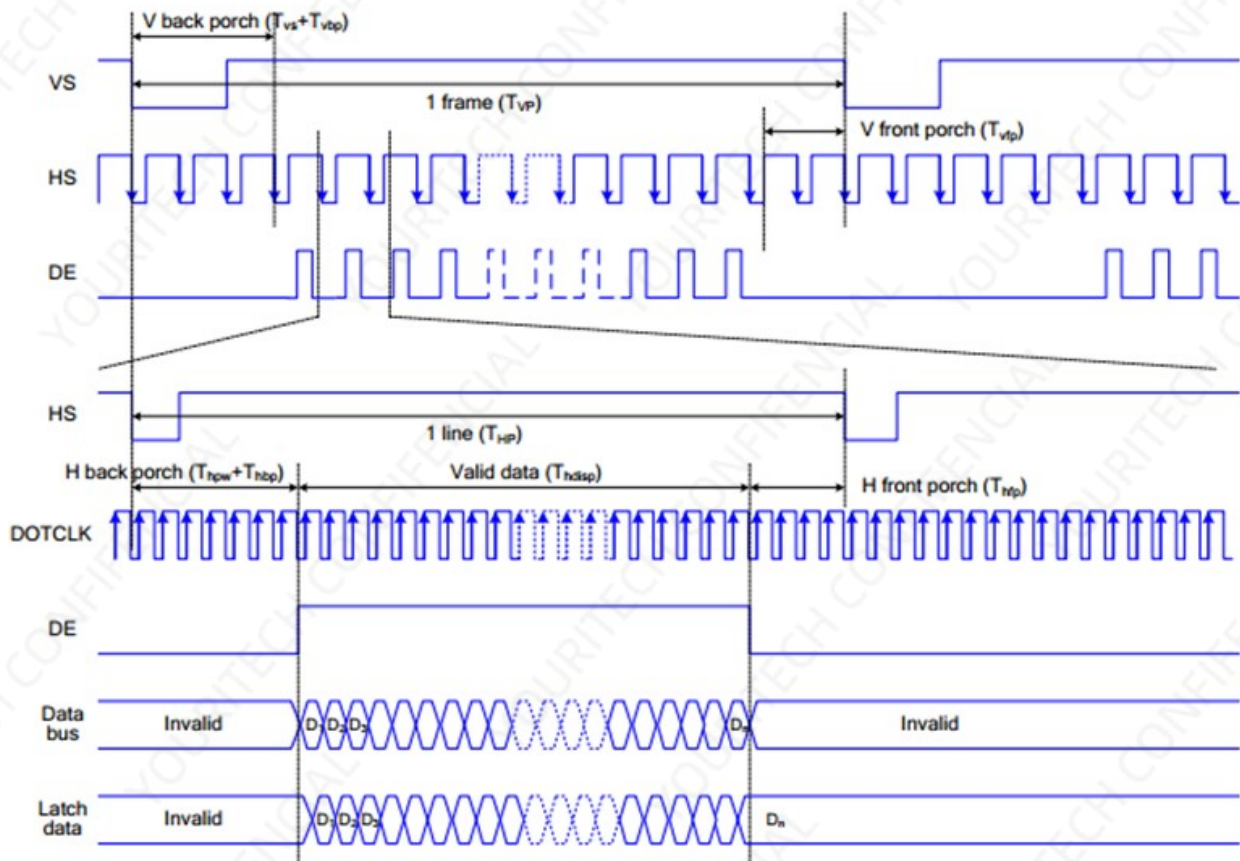
6. Timing Characteristics

SPI interface pause



The CSX can be in high level between the data and the next command.
The SDI(SDA) and SCL are invalid if the CSX is in high level.

The timing chart of RGB interface DE mode is shown as follows.



Please refer to the following table for the setting limitation of RGB interface signals.

Parameter	Symbol	Min.	Typ.	Max.	Unit
Horizontal Sync. Width	hpw	1	-	255	Clock
Horizontal Sync. Back Porch	hbp	1	--	255	Clock
Horizontal Sync. Front Porch	hfp	1	--	-	Clock
Vertical Sync. Width	vs	1	--	254	Line
Vertical Sync. Back Porch	vbp	1	--	254	Line
Vertical Sync. Front Porch	vfp	2	--	--	Line

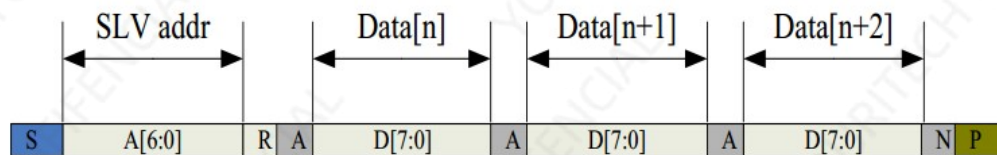
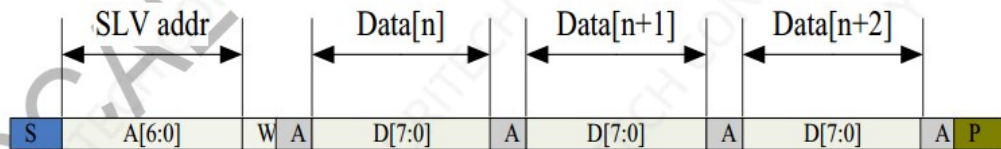
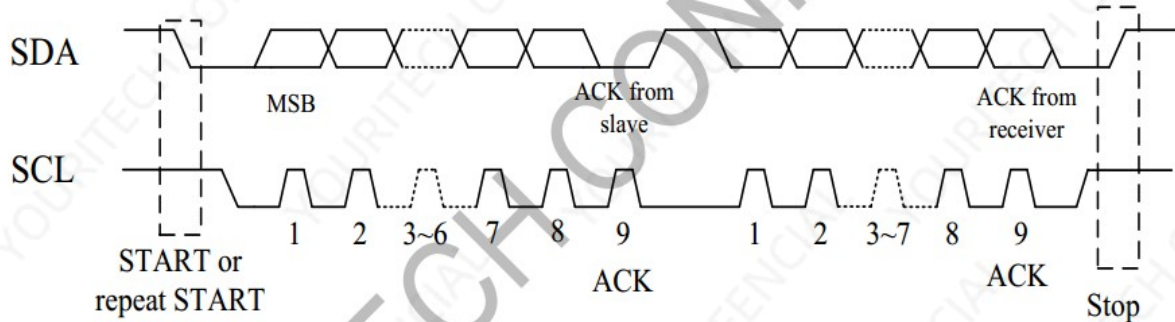
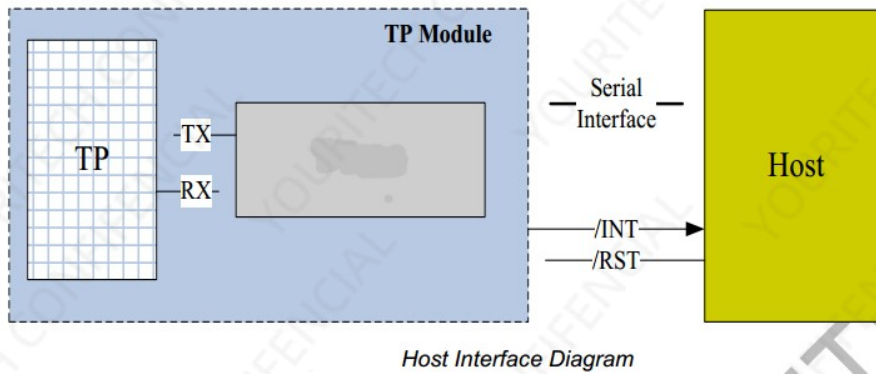


Figure 2-6 I2C master read, slave write

lists the meanings of the mnemonics used in the above figures.

I2C Interface Timing Characteristics is shown in Table 2-2.

Table 2-2 I2C Timing Characteristics

Parameter	Min	Max	Unit
SCL frequency	0	400	KHz
Bus free time between a STOP and START condition	1.3		us
Hold time (repeated) START condition	0.6		us
Data setup time	100		ns
Setup time for a repeated START condition	0.6		us
Setup Time for STOP condition	0.6		us

Reset Description:

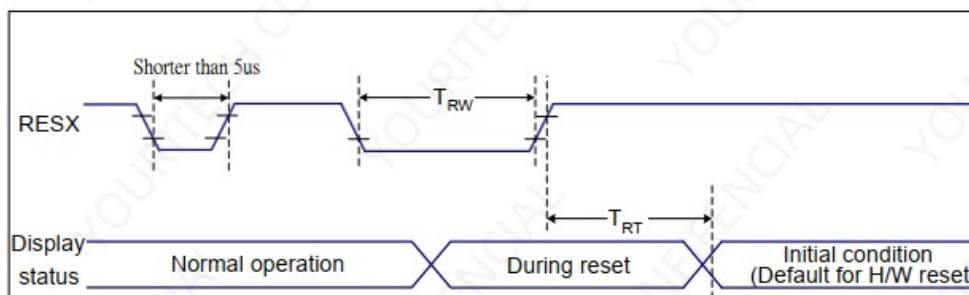


Figure 9 Reset Timing

VDDI=1.8, VDD=2.8, AGND=DGND=0V, Ta=25 °C

Related Pins	Symbol	Parameter	MIN	MAX	Unit
RESX	TRW	Reset pulse duration	10	-	us
	TRT	Reset cancel	-	5 (Note 1, 5)	ms
				120 (Note 1, 6, 7)	ms

Table 9 Reset Timing

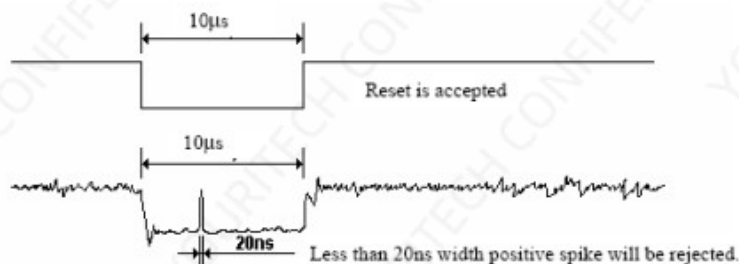
Notes:

1. The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.
2. Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below:

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 9us	Reset
Between 5us and 9us	Reset starts

3. During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode.) and then return to Default condition for Hardware Reset.

4. Spike Rejection also applies during a valid reset pulse as shown below:



5. When Reset applied during Sleep In Mode.
6. When Reset applied during Sleep Out Mode.
7. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

7. Optical Characteristics

7.1 Optical Specification

The test of view angle range shall be measured in a dark room (ambient luminance ≤ 1 lux and temperature $= 25 \pm 2^\circ\text{C}$) with the equipment of Luminance meter system (Gonio meter system and TOPCON CS2000/CA310) and test unit shall be located at an approximate distance 50cm from the LCD surface at a viewing angle of θ and ϕ equal to 0° . We refer to $\theta=0$ ($=\theta_3$) as the 3 o'clock direction (the "right"), $\theta=90$ ($=\theta_{12}$) as the 12 o'clock direction ("upward"), $\theta=180$ ($=\theta_9$) as the 9 o'clock direction ("left") and $\theta=270$ ($=\theta_6$) as the 6 o'clock direction ("bottom"). While scanning θ and/or ϕ , the center of the measuring spot on the Display surface shall stay fixed. The luminance, color and uniformity (etc) should be tested by CS2000/CA310. The backlight should be operating for 10 minutes prior to measurement.

<Table 4. Optical Specifications>

Parameter		Symbol	Condition	Min.	Typ.	Max.	Unit	Remark
Viewing Angle range	Horizontal	Θ_3	CR > 10	80	85	-	Deg.	Note 1
		Θ_9		80	85	-	Deg.	
	Vertical	Θ_{12}		80	85	-	Deg.	
		Θ_6		80	85	-	Deg.	
Contrast ratio		CR	$\Theta = 0^\circ$	1000	1200	-	-	Note 2
Transmittance		Tr		3.91	4.6	-	%	Note 3 @Silicate BLU POL:HC+Clear
Color Gamut	NTSC	CIE1931	$\Theta = 0^\circ$	60	65	-	%	Note 4 CF@C Light(Q-P anel)
Reproduction of color		Rx	$\Theta = 0^\circ$	0.617	0.647	0.677		
		Ry		0.283	0.313	0.343		
		Gx		0.233	0.263	0.293		
		Gy		0.530	0.560	0.590		
		Bx		0.107	0.137	0.167		
		By		0.076	0.106	0.136		
	White	Wx		0.268	0.298	0.328	-	
		Wy		0.297	0.327	0.357	-	
Response Time		Tr+Td	Ta= 25° C $\Theta = 0^\circ$	-	35	40	ms	Note 5

Notes : 1. Viewing angle is the angle at which the contrast ratio is greater than 10. The viewing angles are determined for the horizontal or 3, 9 o'clock direction and the vertical or 6, 12 o'clock direction with respect to the optical axis which is normal to the LCD surface (see FIGURE 1).

2. Contrast measurements shall be made at viewing angle of $\Theta = 0$ and at the center of the LCD surface. Luminance shall be measured with all pixels in the view field set first to white, then to the dark (black) state . (see FIGURE 1) Luminance Contrast Ratio (CR) is defined mathematically.

$$CR = \frac{\text{Luminance when displaying a white raster}}{\text{Luminance when displaying a black raster}}$$

3. Transmittance is the Value with Polarizer(HC+Clear) & silicate BLU (Film structure is on Table 5.1) .

遮光	Soken	SK8906B
BEF	光耀	SG43+QG42
DIF	Kimoto	38TMQ
LGP	住友	TR1801A
REF	丽光	75W28
胶铁	乐天	LB1010W
LED	AOT	3004 Silicate

Table 5

4. The color chromaticity coordinates specified in Table 5. shall be calculated from the spectral data measured with all pixels first in red, green, blue and white. Measurements shall be made at the center of the CF and based on C Light
5. The electro-optical response time measurements shall be made as FIGURE 2. The times needed for the luminance to change from 10% to 90% is T_r , and 90% to 10% is T_f .

8. Reliability Test Item

No.	Test Item	Test Condition	Notes
1	High Temp. Storage	+70°C / 96H	1. Functional test is OK. Missing Segment, short, unclear segment non-display, display abnormally and liquid crystal leakage un-allowed. 2. No low temperature bubbles, end seal loose and fall, frame rainbow.
2	Low Temp. Storage	-20°C / 96H	
3	High Temp. Operating	+80°C / 96H	
4	Low Temp. Operating	-30°C / 96H	
5	High Temperature / Humidity storage	50°C x 90%RH / 96H	
6	Thermal and cold shock	Static state, -20°C (30min) ~70°C (30min), 50 cycles	

9. Packing Method----TBD

- END -